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| FORM PTO-1449 LIST OF PATENTS AND OTHER ITEMS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary) | ATTY. DOCKET NO. H2S001 | SERIAL NO. TBA |
| | APPLICANT: John Patrick Sterchi and Jerry Alan Piontkowski | |
| | FILING DATE: Herewith | GROUP: TBA |

| U.S. PATENT DOCUMENTS | | | | | | | |
|-----------------------|---|-----------------|----------|-------------------|-------|--------------|----------------|
| EXAMINER INITIAL | | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE |
| mzw | A | 6,558,827 | 05/06/03 | Reiser | 429 | 17 | 02/26/01 |
| mzw | B | US 2002/0122969 | 09/05/02 | Herrmann | 429 | 34 | 11/29/01 |
| mzw | C | US 2002/0136942 | 09/26/02 | Kashiwagi | 429 | 34 | 03/13/02 |
| mzw | D | US 2002/0192519 | 12/19/02 | Fujita et al. | 429 | 23 | 06/17/02 |
| mzw | E | 6,034,465 | 03/07/00 | McKee et al. | 310 | 268 | 07/30/98 |
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| mzw | H | 3,601,507 | 08/24/71 | Harris | 417 | 354 | 08/27/69 |
| mzw | I | 5,407,331 | 04/18/95 | Atsumi | 417 | 420 | 01/13/93 |
| mzw | J | US 2003/0035986 | 02/20/03 | Yang | 429 | 25 | 10/05/01 |
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| FOREIGN PATENT DOCUMENTS | | | | | | | |
|--------------------------|--|-----------------|------|---------|-------|--------------|-----------------------|
| EXAMINER INITIAL | | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUB CLASS | TRANSLATION YES NO |
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| OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.) | | |
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| EXAMINER: <i>Monique Wells</i> | DATE CONSIDERED: <i>3/17/06</i> |
| EXAMINER: Please initial if reference is considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include a copy of this form with next communication to applicant. Thank you. | |